

Power Inductor



BKPA Series



Overview

Power inductors are passive electronic components used in various circuits to store energy in a magnetic field when electrical current flows through them. They are critical in filtering, energy storage, and noise suppression in power electronic systems. They are designed to handle higher currents and are optimized for minimal power loss and thermal efficiency.

Benefits

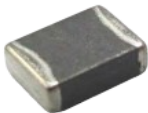
- 1. Energy Storage, Efficiently stores and transfers energy in DC-DC converters and power supplies.
- 2. High Current Handling, Supports high current capacity with minimal losses, ensuring thermal stability.
- 3. Compact and Efficient Design, Advanced materials and construction enable miniaturization without sacrificing performance, ideal for space-constrained designs.

Applications

- 1. Consumer Electronics: Smartphones, laptops, tablets, wearable devices, and gaming consoles.
- 2. Industrial Equipment: Robotics, power tools, industrial automation, and IoT devices.
- 3. DC-DC converters, inverters, and battery management systems.
- 4. Base stations, 5G infrastructure, and signal processing systems.

Product Information

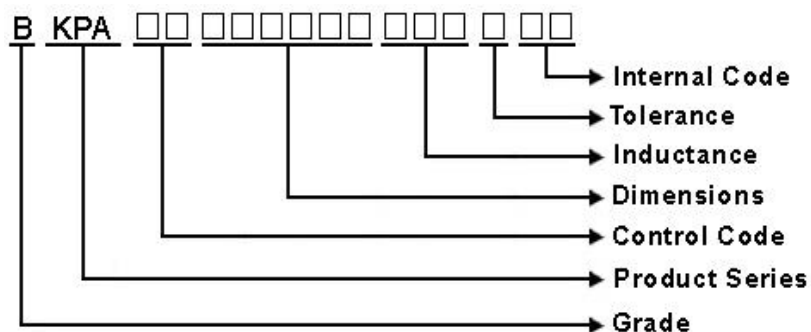
Series	L (mm)	W(mm)	T (mm)	Inductance (μH)
BKPA	2	1.25	1.0	1 ~ 4.7
	2.0	1.25	1.0	
	2.5	2	1.0	



BKPA00252010 Series Specification

1 Scope: This specification applies to Multilayer power inductors

2 Part Numbering:



3 Rating:

Operating Temperature: - 55 °C ~ 125 °C(Including self - temperature rise)

Storage Temperature: - 55 °C ~ 125 °C(after PCB)

- 5 °C~40 °C,Humidity 40 %~70 %(before PCB)

4 Marking:

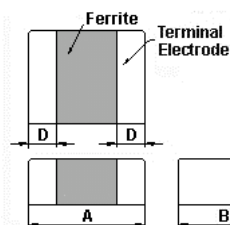
No Marking

5 Standard Testing Condition

	Unless otherwise specified	In case of doubt
Temperature	Ordinary Temperature(15 to 35°C)	20 to 30°C
Humidity	Ordinary Humidity(25 to 85% RH)	50 to 80 %RH

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6 Configuration and Dimensions:



Dimensions in mm

TYPE	252010
A	2.5±0.2
B	2.0±0.2
C	1.0 Max.
D	0.5±0.3

Net Weight (grms)

Size Code	Net Weight (grms)
252010	0.02660

7 Electrical Characteristics:

Part No.	Inductance (uH)	Test Freq.	RDC (Ω)±30%	Rated Current (mA)Max.	Tolerance (±%)
BKPA002520101R0□00	1	1MHz,200mV	0.11	1200	20,30
BKPA002520101R5□00	1.5	1MHz,200mV	0.13	1100	20,30
BKPA002520102R2□00	2.2	1MHz,200mV	0.15	1000	20,30
BKPA002520103R3□00	3.3	1MHz,200mV	0.18	1000	20,30
BKPA002520104R7□00	4.7	1MHz,200mV	0.25	900	20,30

NOTE: □-tolerance M=±20% / T=±30%

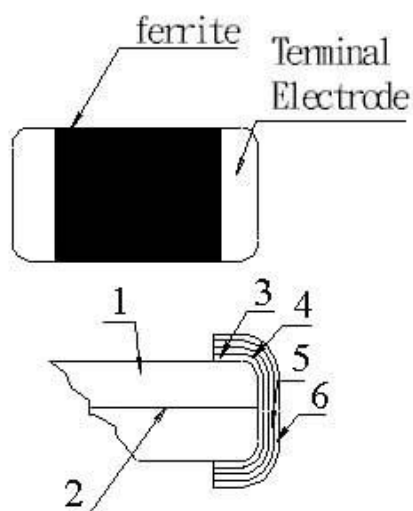
1. Operating temperature range - 5 5°C ~ 1 2 5 °C(Including self - temperature rise)

2. Rate Current : Applied the current to coils, the temperature rise shall not be more than 40°C

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8.1 Construction:



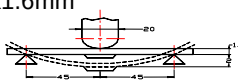
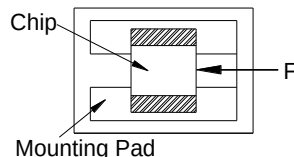
8.2 Material List:

No	Part	Material
1	Ferrite Substance	NiO-CuO-ZnO-Ferrite
2	Silver electrode	Ag
3	Silver electrode	Ag
4	Cu plating	Cu
5	Ni plating	Ni
6	Sn plating	Sn

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9 Reliability Of Ferrite Multilayer power inductors

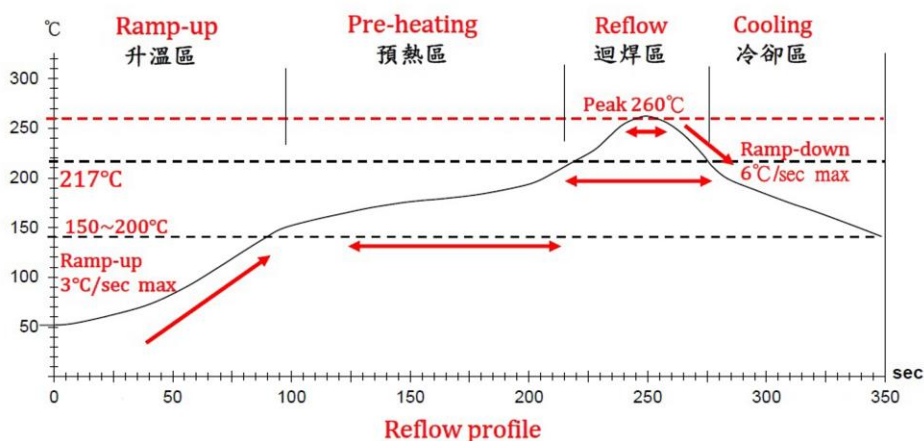
1-1.Mechanical Performance

No	Item	Specification	Test Method
1-1-1	Flexure Strength	The forces applied on the right conditions must not damage the terminal electrode and the ferrite	Test device shall be soldered on the substrate Substrate Dimension: 100x40x1.6mm Deflection: 2.0mm Keeping Time: 30sec 
1-1-2	Vibration		Test device shall be soldered on the substrate Oscillation Frequency: 10 to 55 to 10Hz for 1min Amplitude: 1.5mm Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-1-3	Resistance to Soldering Heat	Appearance: No damage More than 75% of the terminal electrode should be covered with solder. Inductance: within $\pm 20\%$ of initial value	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 260 ± 5 °C Immersion Time: 10 ± 1 sec
1-1-4	Solder ability	The electrodes shall be at least 95% covered with new solder coating	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 245 ± 5 °C Immersion Time: 4 ± 1 sec
1-1-5	Terminal Strength Test	No split termination  Chip Mounting Pad	Test device shall be soldered on the substrate, then apply a force in the direction of the arrow. Force : 5N Keeping Time: 10 ± 1 sec

1-2.Environmental Performance

1-2.Environmental Performance					
No	Item	Specification	Test Method		
1-2-1	Temperature Cycle	Appearance: No damage Inductance:within±20% of initial value	One cycle:		
			Step	Temperature (°C)	Time (min)
			1	-55±3	30
			2	25±2	3
			3	125±3	30
			4	25±2	3
1-2-2	Humidity Resistance		Total: 100cycles Measured after exposure in the room condition for 24hrs		
			Temperature: 40±2℃ Relative Humidity: 90 ~ 95% / Time: 1000hrs Measured after exposure in the room condition for 24hrs		
1-2-3	High Temperature Resistance	Appearance: No damage Inductance:within±30% of initial value	Temperature: 125±3℃ Relative Humidity: 0% / Time: 1000hrs Measured after exposure in the room condition for 24hrs		
1-2-4	Low Temperature Resistance		Temperature: -55±3℃ Relative Humidity: 0% / Time: 1000hrs Measured after exposure in the room condition for 24hrs		

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Lead-Free(LF)標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升温區 Ramp-up	預熱區 Pre-heating	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	R.T ~ 150°C	150°C ~ 200°C	Above 217°C	260±5°C	Peak Temp.~150°C
標準時間 Time spec.	-	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	-
實際時間 Time result	-	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	-

NOTE :

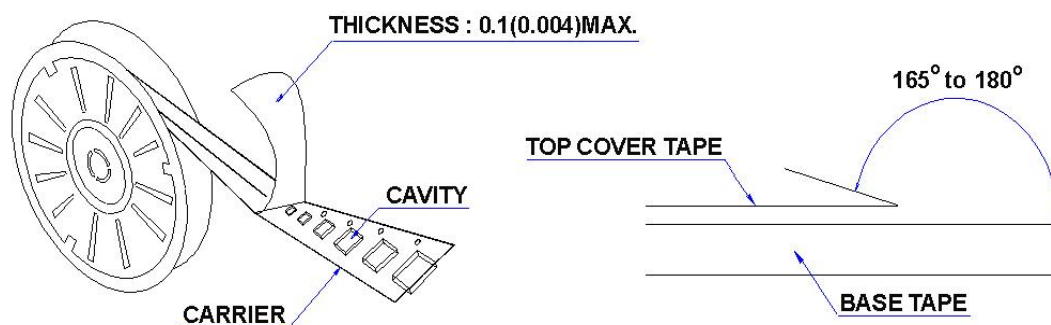
1. Re-flow possible times : within 2 times
2. Nitrogen adopted is recommended while in re-flow
3. Products can only be soldered with reflow

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11 Packaging:

11.1 Packaging -Cover Tape

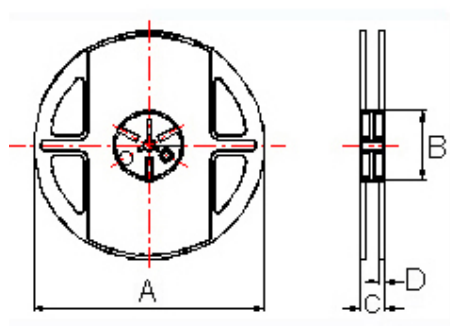
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



11.2 Packaging Quantity

TYPE	PCS/REEL
252010	3000

11.3 Reel Dimensions



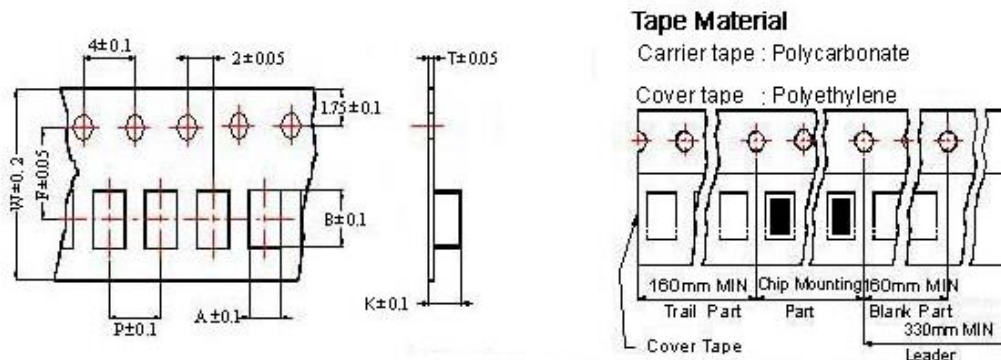
Dimensions in mm

TYPE	A	B	C	D
2520 10	178	60	12	1.5

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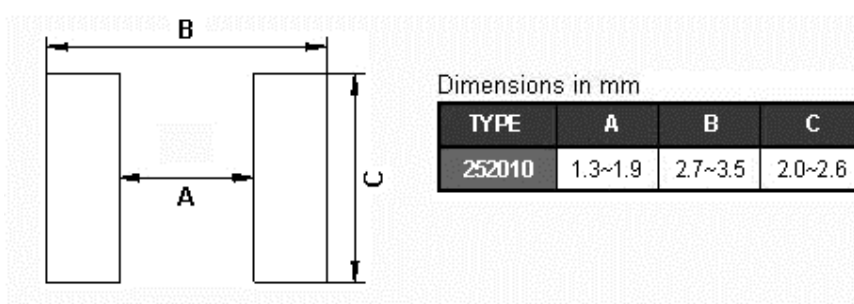
11 Packaging:

11.4 Tape Dimensions in mm



TYPE	A	B	T	W	P	F	K
252010	2.25	2.80	0.25	8	4	3.5	1.35

12 Recommended Land Pattern:

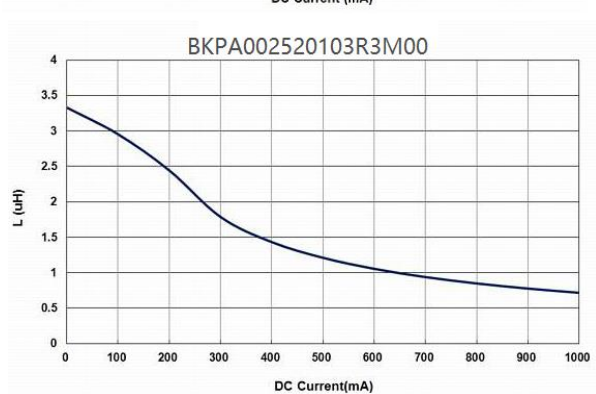
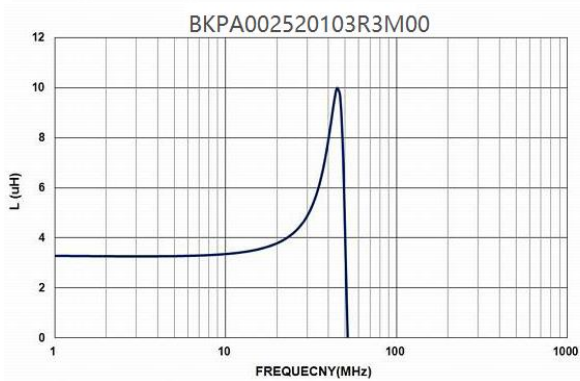
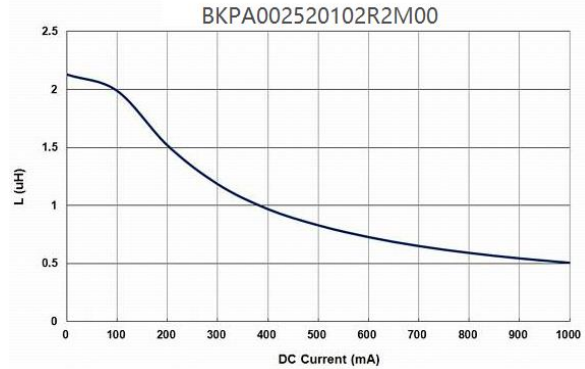
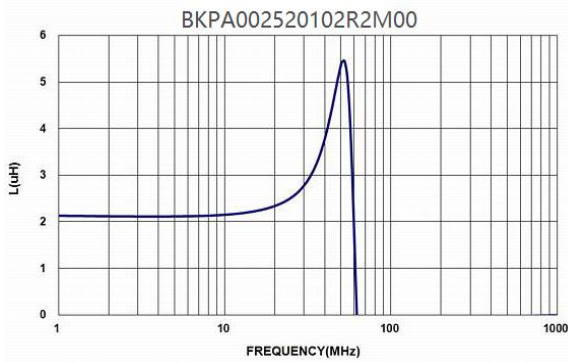
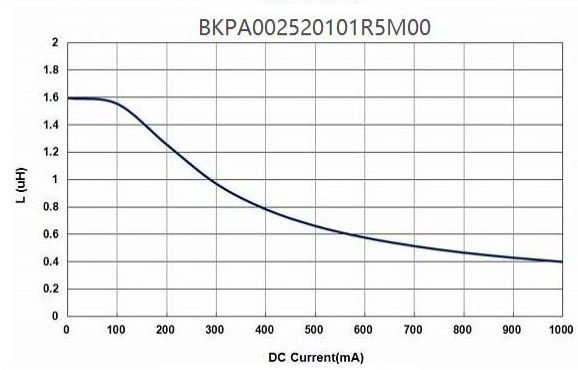
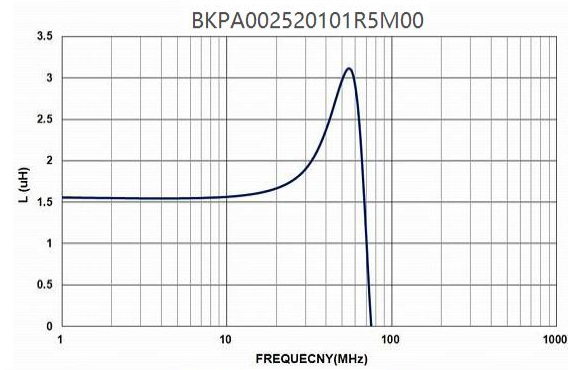
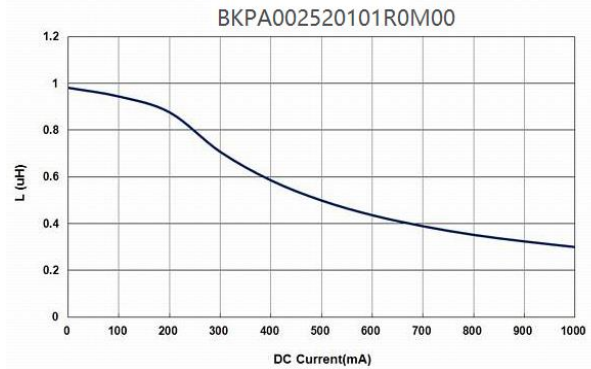
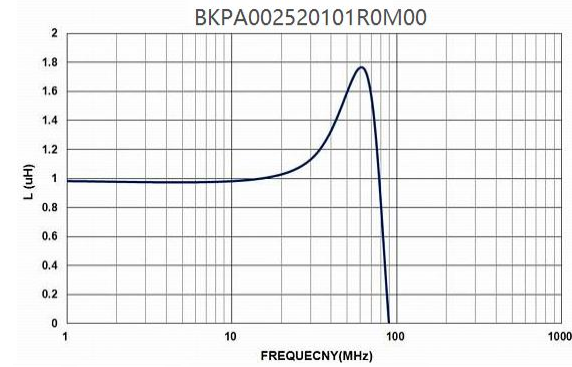


13 Note:

1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
2. Do not knock nor drop.
3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose, under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
5. The moisture sensitivity level (MSL) of products is classified as level 1.

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14 Graph:



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14 Graph:

